

# N-Channel JFET Switch

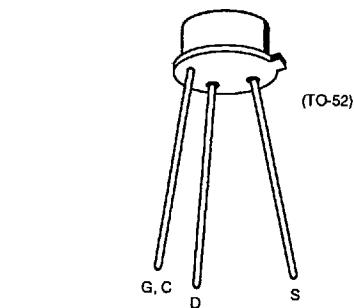
**calogic**  
CORPORATION

## 2N5432 - 2N5434

### FEATURES

- Low  $r_{ds(on)}$
- Excellent Switching
- Low Cutoff Current

### PIN CONFIGURATION



5018

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Gate-Source Voltage	.....	-25V
Gate-Drain Voltage	.....	-25V
Gate Current	.....	100mA
Drain Current	.....	400mA
Storage Temperature Range	.....	-65°C to +200°C
Operating Temperature Range	.....	-55°C to +150°C
Lead Temperature (Soldering, 10sec)	.....	+300°C
Power Dissipation	.....	300mW
Derate above 25°C	.....	2.3mW/°C

NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ORDERING INFORMATION

Part	Package	Temperature Range
2N5432-34	Hermetic TO-52	-55°C to +150°C
X2N5432-34	Sorted Chips in Carriers	-55°C to +150°C

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

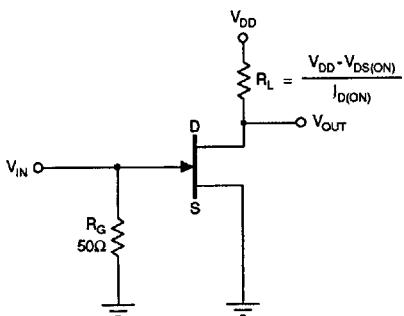
SYMBOL	PARAMETER	2N5432			2N5433			2N5434			UNITS	TEST CONDITIONS
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN		
I <sub>GSS</sub>	Gate Reverse Current	.....	-200	.....	-200	.....	-200	.....	-200	pA	V <sub>GS</sub> = -15V, V <sub>DS</sub> = 0 T <sub>A</sub> = 150°C	
		.....	-200	.....	-200	.....	-200	.....	-200	nA		
BV <sub>GSS</sub>	Gate-Source Breakdown Voltage	-25	.....	-25	.....	-25	.....	.....	.....	V	I <sub>G</sub> = -1μA, V <sub>DS</sub> = 0 V <sub>DS</sub> = 5V, V <sub>GS</sub> = -10V T <sub>A</sub> = 150°C	
		.....	200	.....	200	.....	200	.....	200	pA		
I <sub>D(off)</sub>	Drain Cutoff Current	.....	200	.....	200	.....	200	.....	200	nA	V <sub>DS</sub> = 5V, I <sub>D</sub> = 3nA V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0 T <sub>A</sub> = 150°C	
		.....	200	.....	200	.....	200	.....	200	pA		
V <sub>GS(off)</sub>	Gate-Source Cutoff Voltage	-4	-10	-3	-9	-1	-4	.....	.....	V	V <sub>DS</sub> = 5V, I <sub>D</sub> = 3nA	
I <sub>DSS</sub>	Saturation Drain Current (Note 1)	150	.....	100	.....	30	.....	.....	.....	mA	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0	
r <sub>DS(on)</sub>	Static Drain-Source ON Resistance	2	5	.....	7	.....	10	.....	.....	ohm	V <sub>GS</sub> = 0, I <sub>D</sub> = 10mA	
V <sub>Ds(on)</sub>	Drain-Source ON Voltage	.....	50	.....	70	.....	100	.....	.....	mV	V <sub>GS</sub> = 0, I <sub>D</sub> = 10mA	
r <sub>ds(on)</sub>	Drain-Source ON Resistance	.....	5	.....	7	.....	10	.....	.....	ohm	V <sub>GS</sub> = 0, I <sub>D</sub> = 0 f = 1kHz	
C <sub>iss</sub>	Common-Source Input Capacitance (Note 2)	.....	30	.....	30	.....	30	.....	.....	pF	V <sub>DS</sub> = 0, V <sub>GS</sub> = -10 V f = 1MHz	
C <sub>rss</sub>	Common-Source Reverse Transfer Capacitance (Note 2)	.....	15	.....	15	.....	15	.....	.....	pF	V <sub>DS</sub> = 0, V <sub>GS</sub> = -10 V f = 1MHz	
t <sub>d</sub>	Turn-ON Delay Time (Note 2)	.....	4	.....	4	.....	4	.....	.....	ns	V <sub>DD</sub> = 1.5V, V <sub>GS(on)</sub> = 0, V <sub>GS(off)</sub> = -12V, I <sub>D(on)</sub> = 10mA	
t <sub>r</sub>	Rise Time (Note 2)	.....	1	.....	1	.....	1	.....	.....	ns		
t <sub>off</sub>	Turn-OFF Delay Time (Note 2)	.....	6	.....	6	.....	6	.....	.....	ns		
t <sub>f</sub>	Fall Time (Note 2)	.....	30	.....	30	.....	30	.....	.....	ns		

NOTES: 1. Pulse test required, pulselwidth 300μs, duty cycle ≤3%.

2. For design reference only, not 100% tested.

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**SWITCHING TIME, TEST CIRCUIT**



**INPUT PULSE**

RISE TIME 0.25ns  
FALL TIME 0.75ns  
PULSE WIDTH 200ns  
PULSE RATE 550pps

**SAMPLING SCOPE**

RISE TIME 0.4ns  
INPUT RESISTANCE 10MΩ  
INPUT CAPACITANCE 1.5pF

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